532448-9 - ACTIVE

AMP-HDI

TE Internal #: 532448-9 PCB Mount Header, Vertical, Board-to-Board, 240 Position, 2.54 mm [.1 in] Centerline, Fully Shrouded, Gold, Through Hole - Press-Fit, Signal, Black

View on TE.com >

Connectors > PCB Connectors > PCB Headers & Receptacles



PCB Connector Assembly Type: PCB Mount Header

PCB Mount Orientation: Vertical

Connector System: Board-to-Board

Number of Positions: 240

Number of Rows: 4

Features



Product Type Features

PCB Connector Assembly Type	PCB Mount Header			
Connector System	Board-to-Board			
Header Type	Fully Shrouded			
Sealable	No			
Connector & Contact Terminates To	Printed Circuit Board			
Configuration Features				
Stackable	No			
PCB Mount Orientation	Vertical			
Number of Positions	240			
Number of Rows	4			
Electrical Characteristics				
Insulation Resistance	4 MΩ			
Body Features				
Primary Product Color	Black			

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Contact Features

	30 µin		
Mating Square Post Dimension	.64 mm[.025 in]		
Contact Layout	Matrix		
Contact Shape & Form	Four Beam		
PCB Contact Termination Area Plating Material	Tin		
Contact Base Material	Phosphor Bronze		
Contact Mating Area Plating Material	Gold		
Contact Type	Pin		
Contact Current Rating (Max)	3 A		
Termination Features			
Square Termination Post & Tail Dimension	.64 mm[.025 in]		
Termination Post & Tail Length	6.35 mm[.25 in]		
Termination Method to Printed Circuit Board	Through Hole - Press-Fit		
Mechanical Attachment			
PCB Mount Retention Type	Action/Compliant Tail		
Mating Alignment	Without		

Mating Alignment Type	Keyed				
PCB Mount Retention	With				
PCB Mount Alignment	Without				
Connector Mounting Type	Board Mount				
Housing Features					
Centerline (Pitch)	2.54 mm[.1 in]				
Housing Material	Thermoplastic				
Dimensions					
Connector Height	11.73 mm[.462 in]				
Usage Conditions					
Housing Temperature Rating	High				
Operating Temperature Range	-65 – 125 °C[-85 – 257 °F]				
Operation/Application					
Solder Process Feature	Board Standoff				
Circuit Application	Signal				

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Industry Standards

UL Flammability Rating	UL 94V-0		
Packaging Features			
Packaging Quantity	3		
Packaging Method	Tube		

Product Compliance

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Not Compliant
EU ELV Directive 2000/53/EC	Compliant with Exemptions
China RoHS 2 Directive MIIT Order No 32, 2016	Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JAN 2024 (240) Candidate List Declared Against: JAN 2024 (240) SVHC > Threshold: Pb (13% in Conponent Part) Atice Safe Usage Statements Do not eat, drink or smoke when using this product. Wash thoroughly after handling. Recycle if possible and dispose of the article by following all applicable governmental regulations relevant to your geographic location.

Halogen Content

Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free

Solder Process Capability

Not applicable for solder process capability

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts

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Customers Also Bought



T77S1D10-05	RP 2A 0.25W 1K47 0.1% 25PPM 1K RL	40 SYSTEM 50 HDR DRST SHRD	D-150-0231
II ETE			
TE Part #EK3281-000 CBS-24CN21-41M-9	TE Part #3-5352115-0 Z-PACK/C RAF 55P		

Documents

Product Drawings HDI PIN ASSY 4 ROW 240 POS

English

CAD Files

3D PDF

3D

Customer View Model

ENG_CVM_CVM_532448-9_P.2d_dxf.zip

PCB Mount Header, Vertical, Board-to-Board, 240 Position, 2.54 mm [.1 in] Centerline, Fully Shrouded, Gold, Through Hole - Press-Fit, Signal, Black



English

Customer View Model ENG_CVM_CVM_532448-9_P.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_532448-9_P.3d_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Datasheets & Catalog Pages 1-1773957-5_AMP_HDI_BTB_CONNECTORS_EN

English

Product Specifications Application Specification

English

Instruction Sheets Instruction Sheet (U.S.)

English

Agency Approvals Agency Approval Document

English